# PNZ107, PNZ108 (PN107, PN108)

## Silicon NPN Phototransistors

### For optical control systems

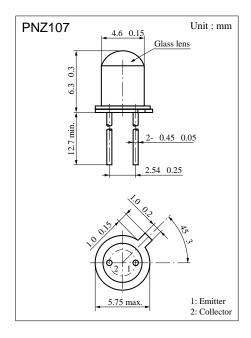
#### Features

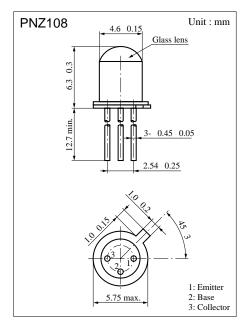
- High sensitivity :  $I_{CE(L)} = 5 \text{ mA (min.)}$  (at L = 100 lx)
- Narrow directional sensitivity for effective use of light input
- Fast response :  $t_r = 5 \mu s$  (typ.)
- Signal mixing capability using base pin (PNZ0108)
- TO-18 standard type package

#### Absolute Maximum Ratings ( $Ta = 25^{\circ}C$ )

Parameter	Symbol	Ratings	Unit	
Collector to emitter voltage	V <sub>CEO</sub>	20	V	
Collector to base voltage	V <sub>CBO</sub> *	30	V	
Emitter to collector voltage	V <sub>ECO</sub>	3	V	
Emitter to base voltage	V <sub>EBO</sub> *	5	V	
Collector current	$I_{C}$	30	mA	
Collector power dissipation	P <sub>C</sub>	150	mW	
Operating ambient temperature	T <sub>opr</sub>	-25 to +85	°C	
Storage temperature	T <sub>stg</sub>	-30 to +100	°C	

<sup>\*</sup> PNZ108 only



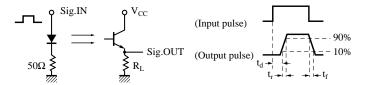


#### ■ Electro-Optical Characteristics (Ta = 25°C)

Parameter	Symbol	Conditions	min	typ	max	Unit
Dark current	$I_{CEO}$	$V_{CE} = 10V$		0.05	2	μΑ
Collector photo current	I <sub>CE(L)</sub>	$V_{CE} = 10V, L = 100 lx^{*1}$	5		15	mA
Peak sensitivity wavelength	$\lambda_{ m P}$	$V_{CE} = 10V$		900		nm
Acceptance half angle	θ	Measured from the optical axis to the half power point		10		deg.
Rise time	t <sub>r</sub> *2	$V_{CC} = 10V, I_{CE(L)} = 5mA$		5		μs
Fall time	$t_f^{*2}$	$R_L = 100\Omega$		6		μs
Collector saturation voltage	V <sub>CE(sat)</sub>	$I_{CE(L)} = 1 \text{mA}, L = 500 \text{ lx}^{*1}$		0.3	0.6	V

<sup>\*1</sup> Measurements were made using a tungsten lamp (color temperature T = 2856K) as a light source.

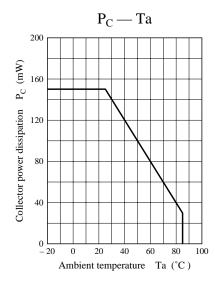
<sup>\*2</sup> Switching time measurement circuit

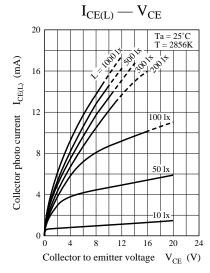


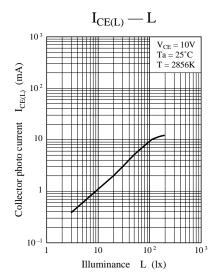
 $t_d$ : Delay time

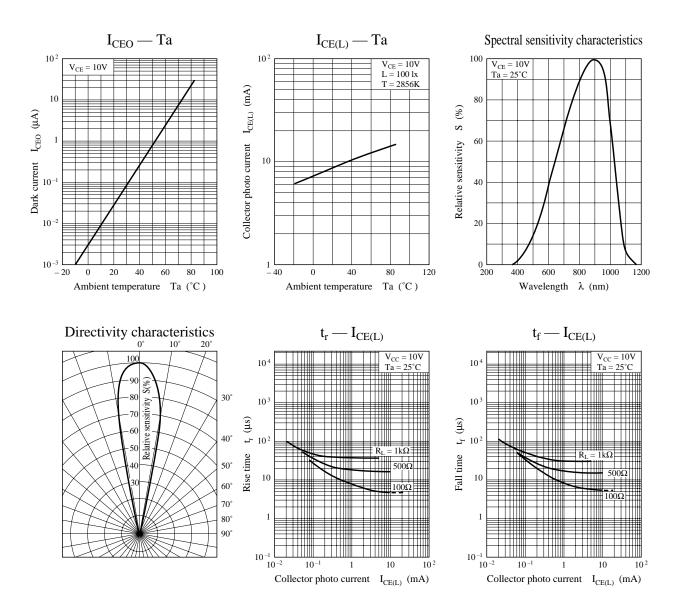
t<sub>r</sub>: Rise time (Time required for the collector photo current to increase from 10% to 90% of its final value)

 $t_f$ : Fall time (Time required for the collector photo current to decrease from 90% to 10% of its initial value)









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